

Non-UV Dicing Tapes Market Size To Reach \$1.55Billion By 2030 At A CAGR Of 9%

The Business Research Company's Non-UV Dicing Tapes Market Report 2026 – Market Size, Trends, And Global Forecast 2026-2035

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/EINPresswire.com/ -- "The [non-UV dicing tapes market](#) has been

experiencing significant growth recently, driven by advancements in semiconductor manufacturing and rising demand for consumer electronics. As this sector evolves, it is set for continued expansion, reflecting broader trends in technology and electronics production. Let's explore the current market status, key growth factors, regional dynamics, and future outlook of the non-UV dicing tapes industry.

Strong Growth and Market Size Outlook of the Non-UV Dicing Tapes Market

The non-UV dicing tapes market has shown robust expansion over recent years. It is forecasted to increase from \$0.99 billion in 2025 to \$1.08 billion in 2026, registering a compound annual growth rate (CAGR) of 9.2%. This past growth has been propelled by several factors, including the rising capacity of semiconductor manufacturing, growing consumer electronics demand, wider use of precision wafer processing techniques, increased integrated circuit production, and improvements in adhesive film technology.

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Looking ahead, the market is expected to maintain this upward trajectory, reaching \$1.55 billion by 2030 with an even stronger CAGR of 9.5%. The projected growth is tied to greater investments in advanced chip fabrication facilities, escalating demand for smaller electronic components, rising adoption of AI-powered semiconductor devices, expansion in electric vehicle electronics manufacturing, and heightened focus on defect-free wafer dicing processes. Key trends anticipated during the forecast include a surge in demand for ultra-thin dicing tapes, increased use of high-precision wafer singulation methods, emphasis on low-residue adhesive materials,



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growth in advanced semiconductor packaging, and utilization of high cleanliness dicing substances.

What Non-UV Dicing Tapes Are and Their Role in Semiconductor Manufacturing

Non-UV dicing tapes are specialized adhesive films used in the semiconductor wafer cutting process to hold wafers securely during singulation and dicing operations. Unlike UV dicing tapes, these do not require exposure to ultraviolet light to reduce adhesive strength. Instead, they provide consistent adhesion and reliable performance throughout the entire wafer cutting procedure. Designed to ensure precise cuts while minimizing chip damage, these tapes also help maintain cleanliness in sensitive, high-precision electronic manufacturing environments.

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How Consumer Electronics Demand Is Boosting the Non-UV Dicing Tapes Market

One of the main drivers of growth in the non-UV dicing tapes market is the ever-increasing demand for consumer electronics. This category includes devices such as smartphones, tablets, laptops, and wearable technology utilized in both personal and professional settings. The rise in consumer electronics consumption is fueled by factors like rapid digitalization, growing disposable incomes, technological advancements, and widespread adoption of smart and connected gadgets. Non-UV dicing tapes play a crucial role in supporting this demand by enabling precise wafer dicing, safeguarding semiconductor components during production, and improving manufacturing yield and efficiency. These benefits translate into enhanced reliability and performance of electronic devices. To illustrate, the International Trade Administration reported in February 2026 that UK eCommerce sales grew nearly 30% during 2024–2025, with electronics being a key category contributing to this surge, thereby reinforcing the market's growth.

The Impact of Increasing 5G Infrastructure Investments on Non-UV Dicing Tapes Market

Another significant factor driving market expansion is the growing investment in 5G infrastructure globally. These investments involve funds allocated by governments, telecom operators, and private entities to build, upgrade, and expand 5G networks, including the deployment of towers, base stations, and supporting semiconductor technologies. The push for faster connectivity, widespread adoption of IoT devices, and the demand for low-latency, highly reliable communication networks are fueling this investment wave. Non-UV dicing tapes contribute by ensuring precision during wafer dicing in the manufacturing of 5G chips and modules, protecting semiconductor components, and enhancing yield and efficiency. For example, in April 2023, the UK government announced a £150 million investment package, with £40 million dedicated specifically to accelerating 5G technology adoption. Such initiatives underline the role of 5G infrastructure growth in driving demand for non-UV dicing tapes.

Regional Outlook and Market Leadership in Non-UV Dicing Tapes

In 2025, North America held the largest share of the global non-UV dicing tapes market. However, the Asia-Pacific region is forecasted to witness the fastest growth moving forward. The market analysis spans multiple regions, including Asia-Pacific, South East Asia, Western and Eastern Europe, North America, South America, the Middle East, and Africa, providing a comprehensive view of global developments in this sector.

Our 2026 reports feature deeper market intelligence with market attractiveness scoring and analysis, total addressable market (TAM) analysis, company scoring matrix graphics and tables, Excel-based forecasting dashboards, market hotspots infographics, key technologies and future trend analysis, and updated graphics and tables.

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